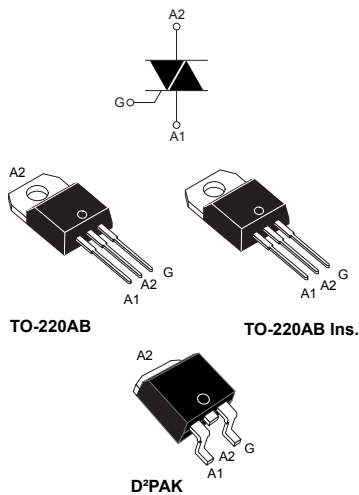


30 A - 600 V H-series Snubberless Triac



Features

- High current Triac
- High immunity level
- Low thermal resistance with clip bonding
- Very high 3 quadrant commutations at 150 °C capabilities
- Packages are RoHS (2002/95/EC) compliant
- UL certified (ref. file E81734)

Applications

Thanks to its high electrical noise immunity level and its strong current robustness, the T3035H, T3050H series is designed for the control of AC actuators in appliances and industrial systems.

Description

Specifically designed to operate at 150 °C, the 30 A triacs T3050H provide very high dynamic and enhanced performance in terms of power loss and thermal dissipation. This allows the heatsink size optimization, leading to space and cost effectiveness when compared to electro-mechanical solutions.

Based on ST Snubberless technology, they offer a specified minimal commutation and high noise immunity levels valid up to the T_j max.

These devices safely optimize the control of universal motors and inductive loads found in power tools and major appliances.

By using an internal ceramic pad, they provide voltage insulation (rated at 2500 V_{RMS}).

Product status link

[T3035H, T3050H](#)

Product summary

$I_{T(RMS)}$	30 A
V_{DRM}/V_{RRM}	600 V
I_{GT}	35 or 50 mA

1 Characteristics

Table 1. Absolute maximum ratings (limiting values)

Symbol	Parameter	Value	Unit	
$I_{T(RMS)}$	RMS on-state current (full sine wave)	D ² PAK, TO-220AB $T_c = 121\text{ °C}$	30	A
		TO-220AB Ins. $T_c = 92\text{ °C}$		
I_{TSM}	Non repetitive surge peak on-state current (full cycle, T_j initial = 25 °C)	f = 50 Hz t = 20 ms	270	A
		f = 60 Hz t = 16.7 ms	284	
I^2t	I^2t value for fusing	$t_p = 10\text{ ms}$	487	A ² s
dI/dt	Critical rate of rise of on-state current, $I_G = 2 \times I_{GT}$, tr ≤ 100 ns, f = 100 Hz	f = 120 Hz $T_j = 150\text{ °C}$	50	A/μs
V_{DSM}/V_{RSM}	Non Repetitive peak off-state voltage	$t_p = 10\text{ ms}$ $T_j = 25\text{ °C}$	$V_{DRM}/V_{RRM} + 100$	V
I_{GM}	Peak gate current	$t_p = 20\text{ μs}$ $T_j = 150\text{ °C}$	4	A
$P_{G(AV)}$	Average gate power dissipation	$T_j = 150\text{ °C}$	1	W
T_{stg}	Storage temperature range		-40 to +150	°C
T_j	Operating junction temperature range		-40 to +150	°C

Table 2. Electrical characteristics ($T_j = 25\text{ °C}$, unless otherwise specified)

Symbol	Test conditions	Quadrants		Value		Unit
				T2035H	T2050H	
$I_{GT}^{(1)}$	$V_D = 12\text{ V}$, $R_L = 33\text{ Ω}$	I - II - III	Max.	35	50	mA
V_{GT}			Max.	1.0		V
V_{GD}	$V_D = V_{DRM}$, $R_L = 3.3\text{ kΩ}$	I - II - III	Max.	0.15		V
I_L	$I_G = 1.2 \times I_{GT}$	I - III	Max.	75	90	mA
		II	Max.	90	110	
$I_H^{(2)}$	$I_T = 500\text{ mA}$, gate open		Max.	60	75	mA
dV/dt ⁽²⁾	$V_D = 2/3 \times V_{DRM}$, gate open	$T_j = 150\text{ °C}$	Min.	1000	1500	V/μs
(dI/dt) _c ⁽²⁾	Without snubber	$T_j = 150\text{ °C}$	Min.	33	44	A/ms

1. Minimum I_{GT} is guaranteed at 20% of I_{GT} max.
2. For both polarities of A2 referenced to A1.

Table 3. Static characteristics

Symbol	Test conditions			Value	Unit
$V_T^{(1)}$	$I_T = 42 \text{ A}$, $t_p = 380 \mu\text{s}$	$T_j = 25 \text{ }^\circ\text{C}$	Max.	1.55	V
$V_{TO}^{(1)}$	Threshold voltage	$T_j = 150 \text{ }^\circ\text{C}$	Max.	0.80	V
$R_D^{(1)}$	Dynamic resistance	$T_j = 150 \text{ }^\circ\text{C}$	Max.	15	m Ω
$I_{DRM}/$ $I_{RRM}^{(2)}$	$V_{DRM} = V_{RRM}$	$T_j = 25 \text{ }^\circ\text{C}$	Max.	10	μA
		$T_j = 150 \text{ }^\circ\text{C}$		8.5	mA
	$V_D = V_R = 400 \text{ V}$, peak voltage	$T_j = 150 \text{ }^\circ\text{C}$	Max.	7	mA

1. For both polarities of A2 referenced to A1.
2. $t_p = 380 \mu\text{s}$

Table 4. Thermal resistance

Symbol	Parameter		Value	Unit
$R_{th(j-c)}$	Junction to case (AC)	D ² PAK, TO-220AB	0.8	$^\circ\text{C/W}$
		TO-220AB Ins.	1.6	
$R_{th(j-a)}$	Junction to ambient ($S_{cu} = 2 \text{ cm}^2$)	D ² PAK, TO-220AB	45	$^\circ\text{C/W}$
		Junction to ambient	TO-220AB Ins.	

1.1 Characteristics (curves)

Figure 1. Maximum power dissipation versus on-state RMS current

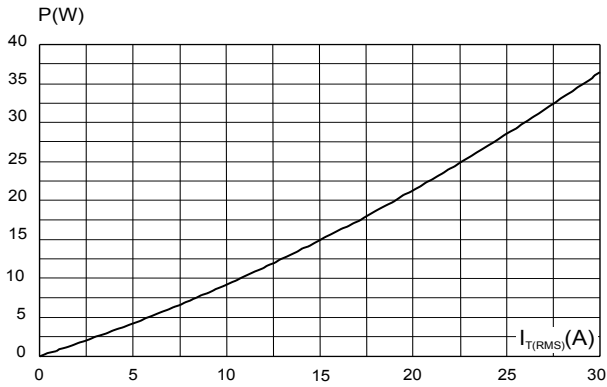


Figure 2. On-state RMS current versus case temperature

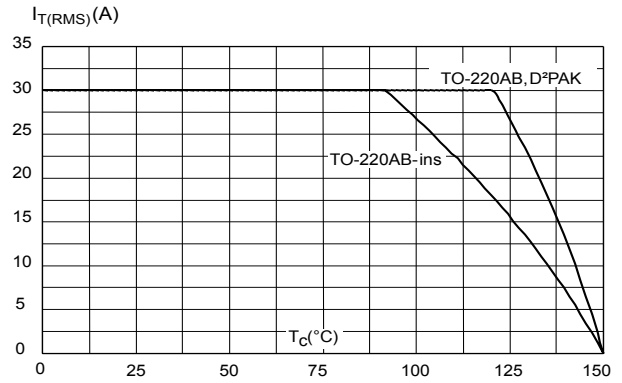


Figure 3. On-state RMS current versus ambient temperature (free air convection)

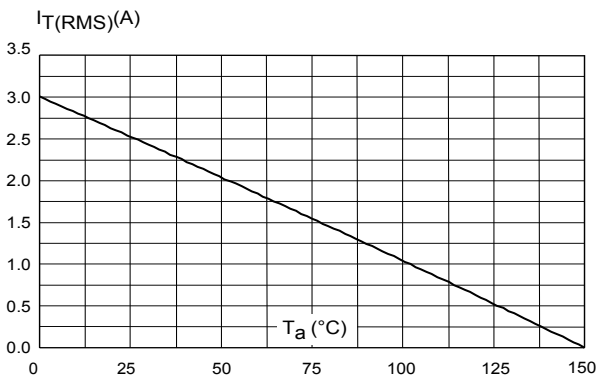


Figure 4. Variation of thermal impedance versus pulse duration

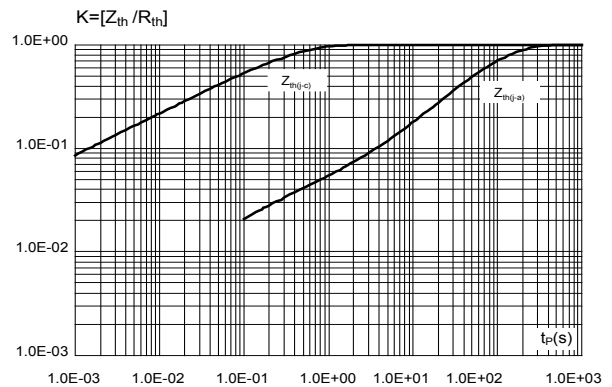


Figure 5. Relative variation of gate trigger current and gate trigger voltage versus junction temperature

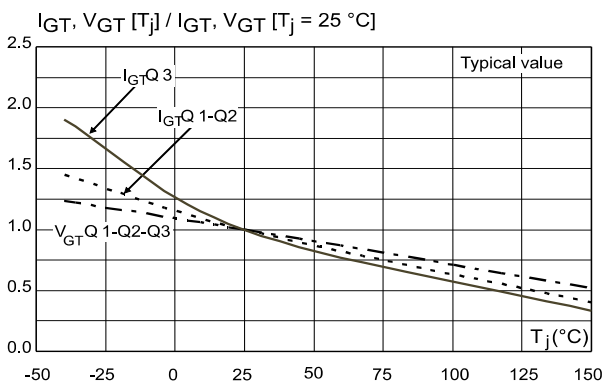


Figure 6. Relative variation of holding current and latching current versus junction temperature (typical value)

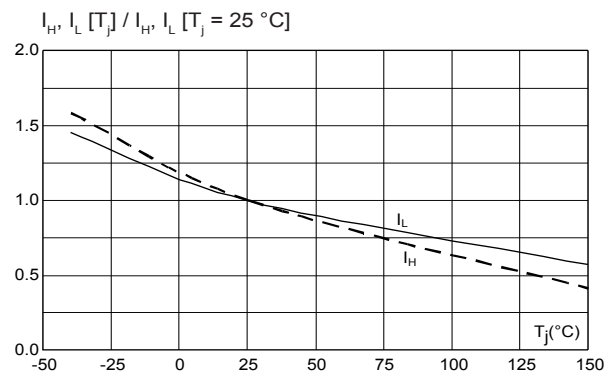


Figure 7. Surge peak on-state current versus number of cycles

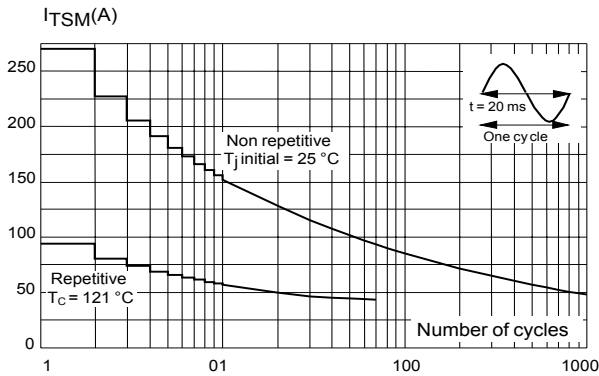


Figure 8. Non-repetitive surge peak on-state current for a sinusoidal pulse with width $t_p < 10$ ms

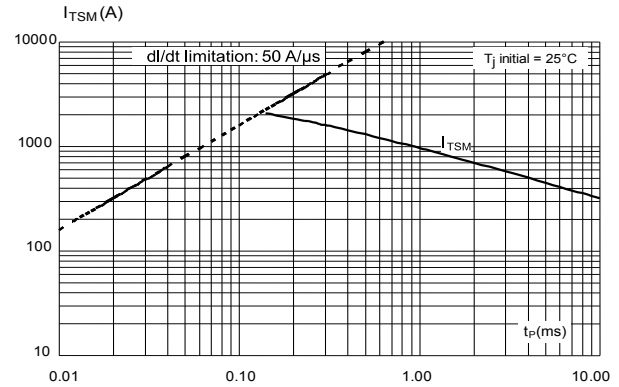


Figure 9. On-state characteristics (maximum values)

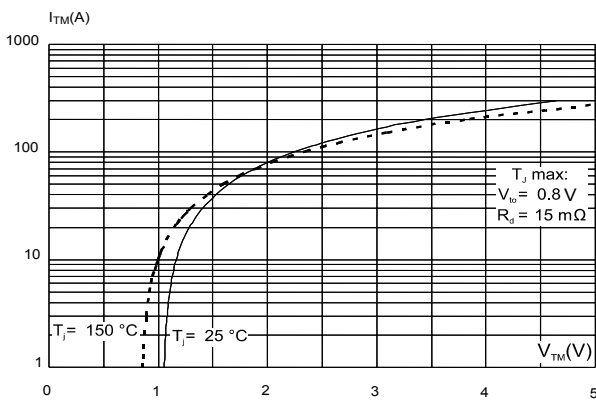


Figure 10. Relative variation of critical rate of decrease of main current versus junction temperature

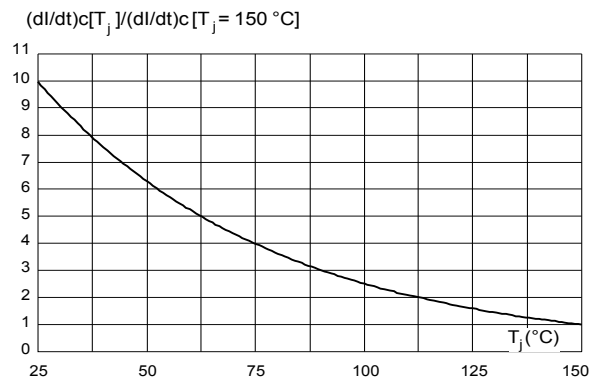


Figure 11. Relative variation of static dV/dt immunity versus junction temperature

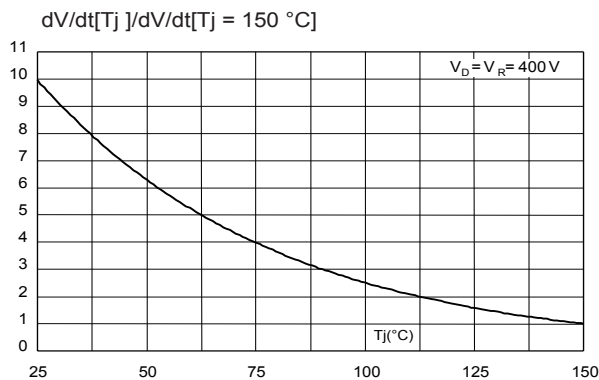


Figure 12. Relative variation of leakage current versus junction temperature for different values of blocking voltage

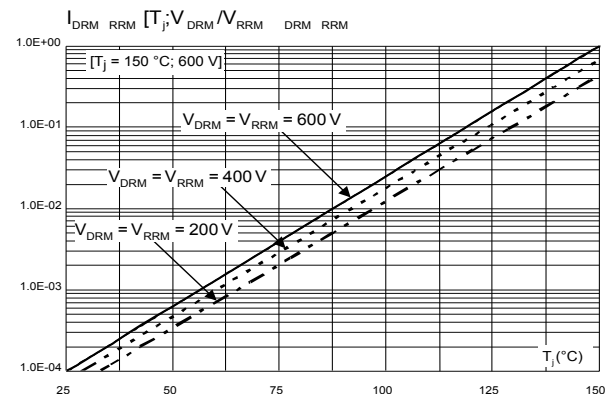


Figure 13. Thermal resistance junction to ambient versus copper surface under tab

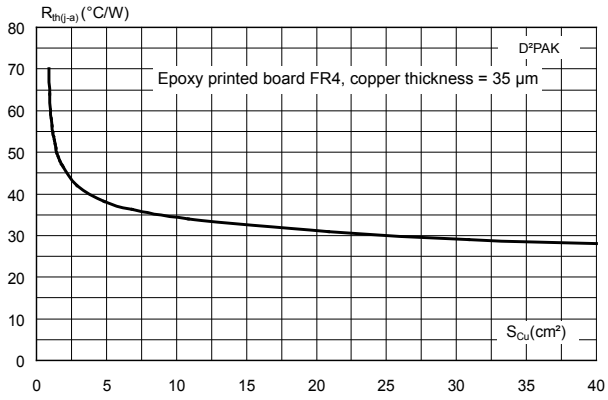
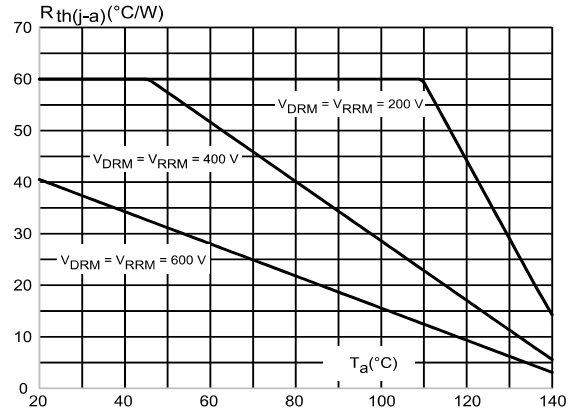


Figure 14. Acceptable junction to ambient thermal resistance versus repetitive peak off-state voltage and ambient temperature

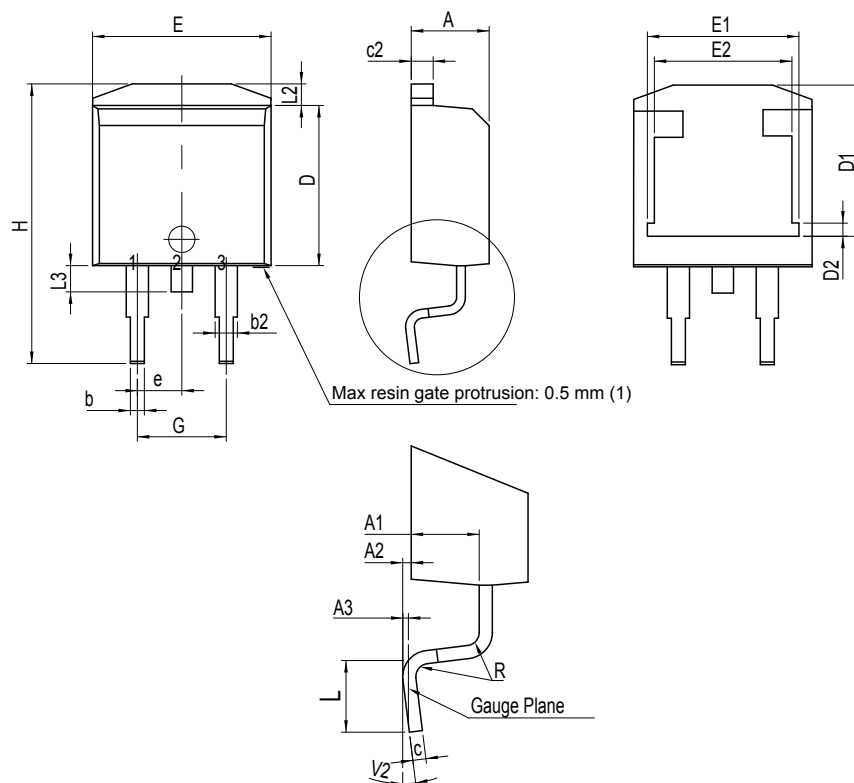


2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of **ECOPACK** packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 D²PAK package information

Figure 15. D²PAK package outline

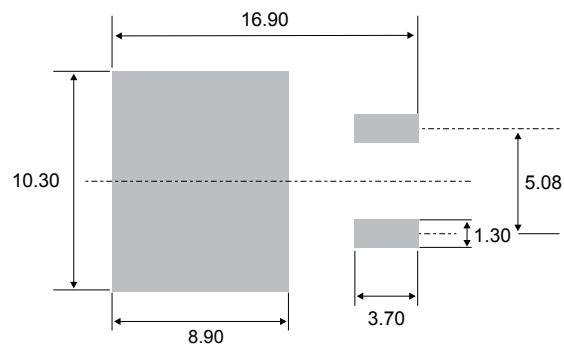


(1) Resin gate is accepted in each of position shown on the drawing, or their symmetrical.

Table 5. D²PAK package mechanical data

Ref.	Dimensions					
	Millimeters			Inches ⁽¹⁾		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.30		4.60	0.1693		0.1811
A1	2.49		2.69	0.0980		0.1059
A2	0.03		0.23	0.0012		0.0091
A3		0.25			0.0098	
b	0.70		0.93	0.0276		0.0366
b2	1.25		1.7	0.0492		0.0669
c	0.45		0.60	0.0177		0.0236
c2	1.21		1.36	0.0476		0.0535
D	8.95		9.35	0.3524		0.3681
D1	7.50		8.00	0.2953		0.3150
D2	1.30		1.70	0.0512		0.0669
e	2.54			0.1		
E	10.00		10.28	0.3937		0.4047
E1	8.30		8.70	0.3268		0.3425
E2	6.85		7.25	0.2697		0.2854
G	4.88		5.28	0.1921		0.2079
H	15		15.85	0.5906		0.6240
L	1.78		2.28	0.0701		0.0898
L2	1.27		1.40	0.0500		0.0551
L3	1.40		1.75	0.0551		0.0689
R		0.40			0.0157	
V2	0°		8°	0°		8°

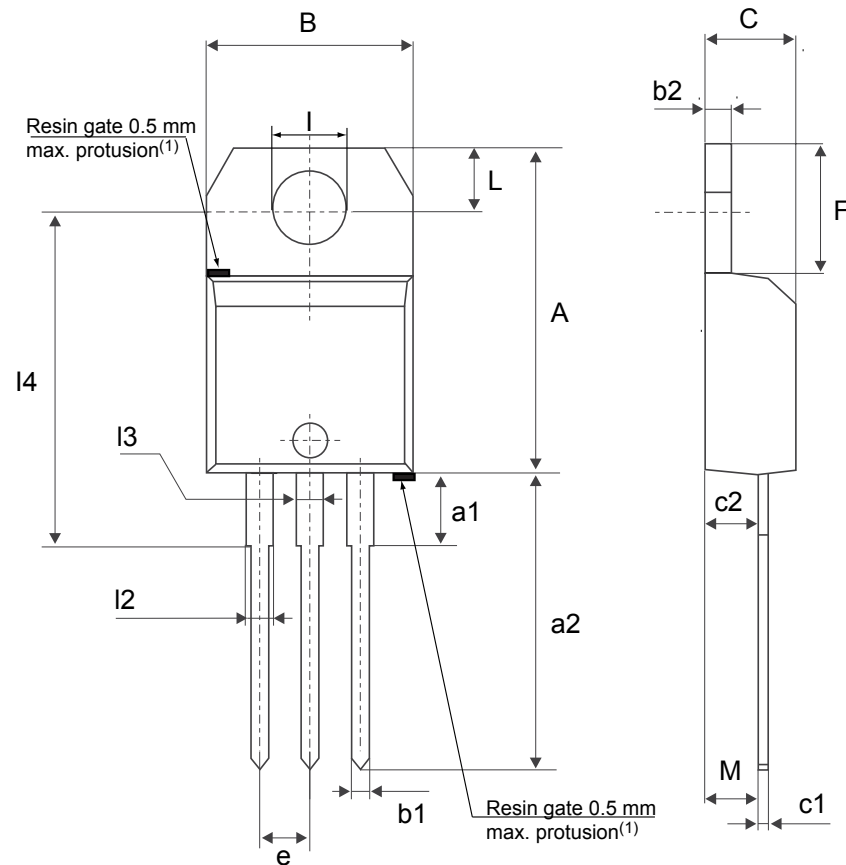
1. Dimensions in inches are given for reference only

Figure 16. D²PAK recommended footprint (dimensions are in mm)


2.2 TO-220AB package information

- Molding compound resin is halogen-free and meets flammability standard UL94 level 0
- Lead-free package leads finishing
- [ECOPACK2](#) compliant
- Recommended torque: 0.4 to 0.6 N.m

Figure 17. TO-220AB package outline



(1) Resin gate position accepted in one of the two positions or in the symmetrical opposites.

Table 6. TO-220AB package mechanical data

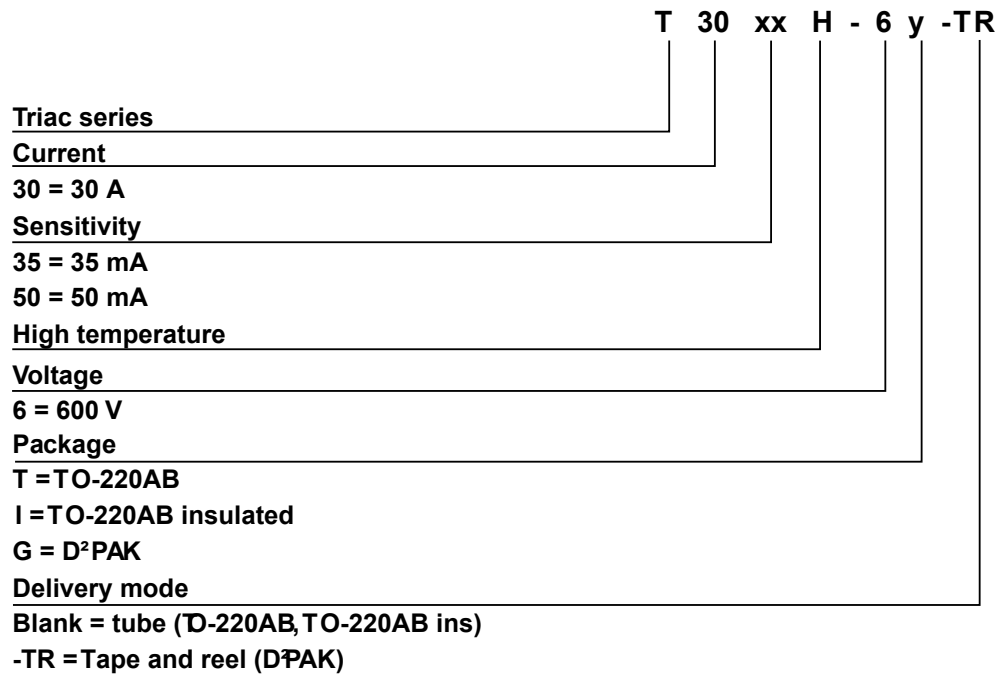
Ref.	Dimensions					
	Millimeters			Inches ⁽¹⁾		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	15.20		15.90	0.5984		0.6260
a1		3.75			0.1476	
a2	13.00		14.00	0.5118		0.5512
B	10.00		10.40	0.3937		0.4094
b1	0.61		0.88	0.0240		0.0346
b2	1.23		1.32	0.0484		0.0520
C	4.40		4.60	0.1732		0.1811
c1	0.49		0.70	0.0193		0.0276
c2	2.40		2.72	0.0945		0.1071
e	2.40		2.70	0.0945		0.1063
F	6.20		6.60	0.2441		0.2598
I	3.73		3.88	0.1469		0.1528
L	2.65		2.95	0.1043		0.1161
I2	1.14		1.70	0.0449		0.0669
I3	1.14		1.70	0.0449		0.0669
I4	15.80	16.40	16.80	0.6220	0.6457	0.6614
M		2.6			0.1024	

1. Inch dimensions are for reference only.

3 Ordering information

Figure 18. Ordering information scheme

Table 7.



Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
T3035H-6G	T2035H-6G	D ² PAK	1.5 g	50	Tube
T3035H-6G-TR	T2035H-6G			1000	Tape and reel 13"
T3035H-6I	T3035H-6I	TO-220AB Ins.	2.3 g	50	Tube
T2035H-6T	T3035H-6T	TO-220AB	2.3 g	50	Tube
T2050H-6G	T3050H-6G	D ² PAK	1.5 g	50	Tube
T2050H-6G-TR	T3050H-6G			1000	Tape and reel 13"
T2050H-6T	T3050H-6T	TO-220AB	2.3 g	50	Tube

Revision history

Table 8. Document revision history

Date	Version	Changes
28-Jan-2010	1	Initial release.
17-May-2010	2	Updated maximum Tj in Table 2.
14-Dec-2010	3	Updated IGT in Table 1.
20-Sep-2011	4	Updated: Features.
21-Jul-2015	5	Update Table 2 and reformatted to current standard.
20-Jan-2017	6	D ² PAK package added.
17-Nov-2021	7	Updated Description and Table 2. Minor text changes.

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